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## **AMENDMENTS TO THE CLAIMS**

This listing of claims will replace all prior versions, and listings, of claims in the application.

## **Listing of Claims:**

1. - 13. (Canceled)

14. (Previously Presented) A semiconductor memory device, including:

a first bit line;

a second bit line;

a first redundant bit line;

a second redundant bit line;

a plurality of first memory cells connected to said first bit line;

a plurality of second memory cells connected to said second bit line;

a plurality of first redundant memory cells connected to said first redundant bit line;

a plurality of second redundant memory cells connected to said second redundant bit line;

a first amplifier circuit connected to said first bit line and said second bit line to amplify a difference of potential between said first bit line and said second bit line; and

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a first redundant amplifier circuit connected to said first redundant bit line and said second redundant bit line to amplify a difference of potential between said first redundant bit line and said second redundant bit line,

wherein said first bit line is to be replaced with said first redundant bit line but said second bit line is not to be replaced with said second redundant bit line.

15. (Previously Presented) A semiconductor memory device according to claim 14, wherein said first bit line and said first redundant bit line are included in a first memory array,

said second bit line and said second redundant bit line being included in a second memory array, and

said first amplifier circuit and said first redundant amplifier circuit being formed in a region between said first memory array and said second memory array.

16. (Original) A semiconductor memory device according to claim 15, wherein said second memory array further includes a third bit line,

said semiconductor memory device further including a third memory array including a fourth bit line and a second amplifier circuit connected to said third bit line and said fourth bit line to amplify a potential difference between said third bit line and said fourth bit line; and

said second amplifier circuit being formed in a region between said second memory array and said third memory array.

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17. (Original) A semiconductor memory device according to claim 14, wherein said first bit line, said second bit line, said first redundant bit line and said second redundant bit line are included in said first memory array,

said first bit line and said second bit line being arranged in parallel; and said first redundant bit line and said second redundant bit line being arranged in parallel.

18. (Previously Presented) A semiconductor memory device according to claim 17, wherein said first memory array further includes a third bit line and a fourth bit line,

said semiconductor memory device further including a second amplifier circuit connected to said third bit line and said fourth bit line to amplify a potential difference between said third bit line and said fourth bit line;

said first amplifier circuit and said first redundant amplifier circuit being formed in a first region;

said second amplifier circuit being formed in a second region; and said first memory array being formed in a region between said first region and said second region.

19. (Original) A semiconductor memory device according to claim 14, wherein said first bit line, said second bit line, said first redundant bit line and said second redundant bit line are included in a first memory array.

20. - 28. (Cancelled)

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29. (Original) A semiconductor memory device, including:

- a plurality of first normal bit lines;
- a plurality of second normal bit lines;
- a first redundant bit line;
- a second redundant bit line;
- a plurality of first normal memory cells connected to said plurality of first normal bit lines;
- a plurality of second normal memory cells connected to said plurality of second normal bit lines;
- a plurality of first redundant memory cells connected to said first redundant bit line;
- a plurality of second redundant memory cells connected to said second redundant bit line;
- a plurality of first amplifier circuits connected to said plurality of first bit lines and said plurality of second bit lines;
- a second amplifier circuit connected to said first redundant bit line and said second redundant bit line to amplify a potential difference between said first redundant bit line and said second redundant bit line; and

an information hold circuit which holds information about replacement of a normal bit line with a redundant bit line,

wherein each of said first amplifier circuits amplifies a potential difference between a corresponding one of said first normal bit lines and a corresponding one of said second normal bit lines, Application No.: 10/627,769

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said information hold circuit replacing one of said first normal bit lines with

said first redundant bit line but not replacing one of said second normal bit lines

corresponding to said one of said first normal bit lines with said second redundant bit

line.

30. (Previously Presented) A semiconductor memory device according to

claim 29, wherein said information hold circuit can hold information to replace one of

said second normal bit lines with said second redundant bit line but not to replace

one of said first normal bit lines corresponding to said one of said second normal bit

lines with said first redundant bit line.

31. (Previously Presented) A semiconductor memory device according to

claim 29, wherein said information hold circuit can hold information that one of said

first normal bit lines is to be replaced with said second redundant bit line and one of

said second normal bit lines with said first redundant bit line.

32. (Previously Presented) A semiconductor memory device according to

claim 29, wherein said information hold circuit can hold information that one of said

first normal bit lines connected to one of said first amplifier circuits and one of said

second normal bit lines are to be respectively replaced with said first redundant bit

line and said second redundant line.

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33. (Previously Presented) A semiconductor memory device according to claim 29, wherein said information hold circuit can hold information that one of said first normal bit lines connected to one of said first amplifier circuits is to be replaced with said first redundant bit line and one of said second normal bit lines connected to another of said first amplifier circuits is to be replaced with said second redundant bit line.